

# Request for Bids

## Goods

(One-Envelope Bidding Process)

**Country:** Kingdom of Cambodia  
**Name of Project:** Higher Education Improvement Project  
**Contract Title:** SUPPLY, DELIVERY, AND INSTALLATION OF LABORATORY EQUIPMENT  
**Credit No.:** IDA Credit 6221-KH  
**RFB Ref.:** MoEYS-HEIP-ICB-G-006

1. The Royal Government of Cambodia (RGC) has received financing from the International Development Association (IDA), World Bank toward the cost of the Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), IDA Credit No. 6221-KH and intends to apply part of the proceeds toward payments under the contract for Supply, Delivery and Installation of Laboratory Equipment. Ref. # MoEYS-HEIP-ICB-G-006.
2. The Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS) now invites sealed Bids from eligible Bidders for Supply, Delivery and Installation of Laboratory Equipment. The final delivery destination is : Royal University of Phnom Penh (RUPP). The delivery period is: **150 – 180 calendar days**.

The Package consists of **3 Lots** as listed in the bidding document and the Bidders may bid for one Lot or multiple Lots. The Bidder evaluation and qualification criteria are included in the bidding document. The bid evaluation will be on a Lot-wise-basis.
3. Bidding will be conducted through international competitive procurement using a Request for Bids (RFB) as specified in the World Bank’s “Procurement Regulations for IPF Borrowers”, dated July 1, 2016; revised in November 2017 and is open to all eligible Bidders as defined in the Procurement Regulations.
4. Interested eligible Bidders may obtain further information from the Higher Education Improvement Project (HEIP), and inspect the bidding document at the address given below on **03 May 2022 to 21 June 2022 from 08:00 – 12:00 and 13:30 – 17:30 hours (Cambodia Time)**, Monday through Friday, except public holidays.
5. The bidding document in English may be obtained by interested Bidders upon the submission of a written application to the address below. The document is free of charge.

6. Bids must be delivered to the address below on or before **10.00 am on 22 June 2022 (Cambodia Time)**. Electronic Bidding will not be permitted. Late Bids will be rejected. Bids will be publicly opened in the presence of the Bidders' designated representatives and anyone who chooses to attend at the address below at **10.00 am on 22 June 2022 (Cambodia Time)**.
7. All Bids must be accompanied by a Bid Securing Declaration
8. Attention is drawn to the Procurement Regulations requiring the Borrower to disclose information on the successful bidder's beneficial ownership, as part of the Contract Award Notice, using the Beneficial Ownership Disclosure Form as included in the bidding document."
9. The addresses referred to above is are:
  - (i) Obtaining information and collection of bidding document from: [chey.sith@moeys.gov.kh](mailto:chey.sith@moeys.gov.kh) and copy to [luon.monkol@moeys.gov.kh](mailto:luon.monkol@moeys.gov.kh), and [va.sith.pu@moeys.gov.kh](mailto:va.sith.pu@moeys.gov.kh)
  - (ii) Submitting bid document, and opening of bids:  
Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), Project Procurement Unit's meeting room of MoEYS, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia.

Attention: **Mr. Chey Sith**, Deputy Director General of Administration and Finance, MoEYS and Chief of Project Procurement Unit, HEIP, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia. Phone: (+855) 016 478 578, 12 444 401, 12 818 818, Email: [chey.sith@moeys.gov.kh](mailto:chey.sith@moeys.gov.kh) and copy to [luon.monkol@moeys.gov.kh](mailto:luon.monkol@moeys.gov.kh) and [va.sith.pu@moeys.gov.kh](mailto:va.sith.pu@moeys.gov.kh).